

# SF1005FCT THRU SF1060FCT

## List

List..... 1

Package outline..... 2

Features..... 2

Mechanical data..... 2

Maximum ratings .....2

Rating and characteristic curves..... 3

Pinning information.....4

Marking..... 4

Tube packing.....4

Suggested thermal profiles for soldering processes..... 5

High reliability test capabilities.....6



# SF1005FCT THRU SF1060FCT

## 10A Super Fast Recovery Rectifiers - 50V-600V

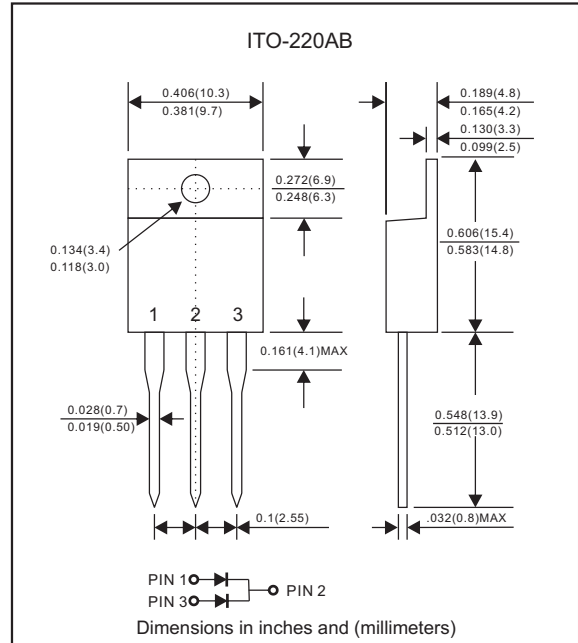
### Features

- Dual rectifier construction, positive centetap, offer 5.0A half wave and 10.0A full wave rectification
- High surge current capability.
- Super fast recovery time for switching mode application.
- Low power loss.
- Glass passivated chip junctions.
- Lead-free parts meet environmental standards of MIL-STD-19500/228
- Suffix "-H" indicates Halogen-free parts, ex. SF1005FCT-H.

### Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC ITO-220AB molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guaranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : Approximated 1.70 gram

### Package outline



### Maximum ratings and Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	$I_o$			10.0	A
Forward surge current	8.3ms single half sine-wave (JEDEC methode)	$I_{FSM}$			100	A
Reverse current	$V_R = V_{RRM} T_J = 25^{\circ}\text{C}$	$I_R$			5.0	$\mu\text{A}$
	$V_R = V_{RRM} T_J = 100^{\circ}\text{C}$				250	
Storage temperature		$T_{STG}$	-65		+175	$^{\circ}\text{C}$

SYMBOLS	$V_{RRM}^{*1}$ (V)	$V_{RMS}^{*2}$ (V)	$V_R^{*3}$ (V)	$V_F^{*4}$ (V)	$t_{rr}^{*5}$ (ns)	Operating temperature $T_J$ ( $^{\circ}\text{C}$ )
SF1005FCT	50	35	50	0.95	35	-55 to +150
SF1010FCT	100	70	100			
SF1020FCT	200	140	200			
SF1040FCT	400	280	400	1.30		
SF1060FCT	600	420	600	1.70		

- \*1 Repetitive peak reverse voltage
- \*2 RMS voltage
- \*3 Continuous reverse voltage
- \*4 Maximum forward voltage@ $I_F = 5.0\text{A}$
- \*5 Maximum Reverse Recovery Time, note 1

Note: 1.Reverse recovery time test condition,  $I_F=0.5\text{A}$ ,  $I_R=1.0\text{A}$ ,  $I_{RR}=0.25\text{A}$

# Rating and characteristic curves (SF1005FCT THRU SF1060FCT)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

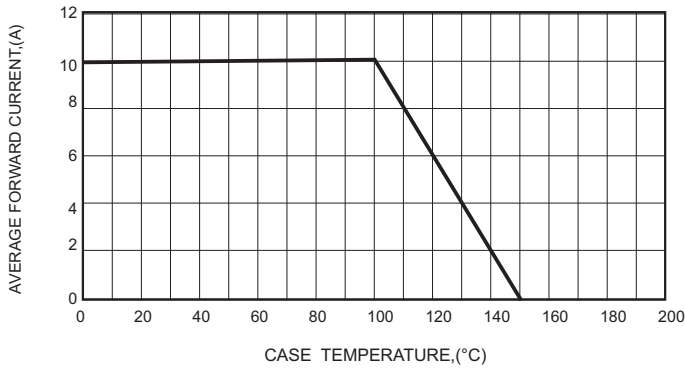


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

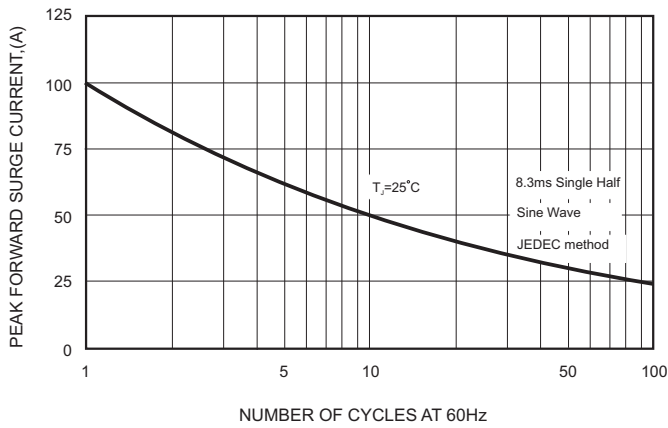


FIG.2-TYPICAL FORWARD CHARACTERISTICS

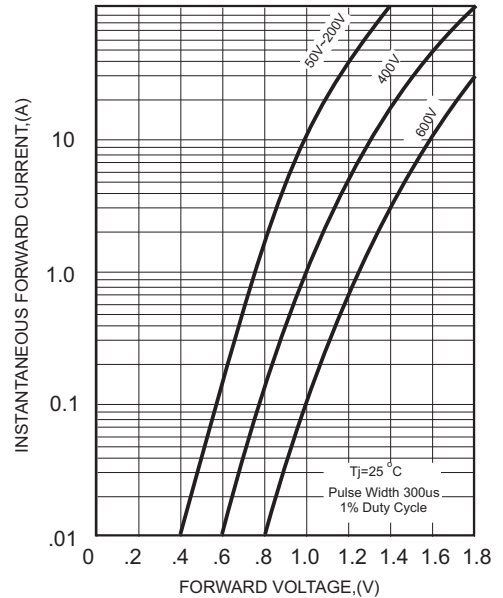


FIG.4 - TYPICAL REVERSE CHARACTERISTICS

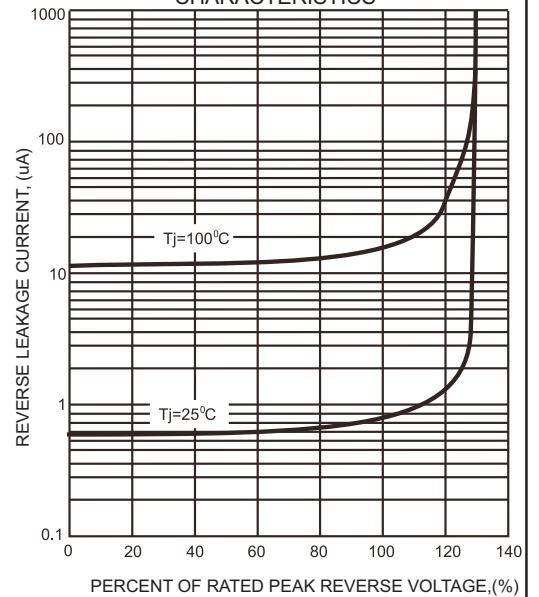
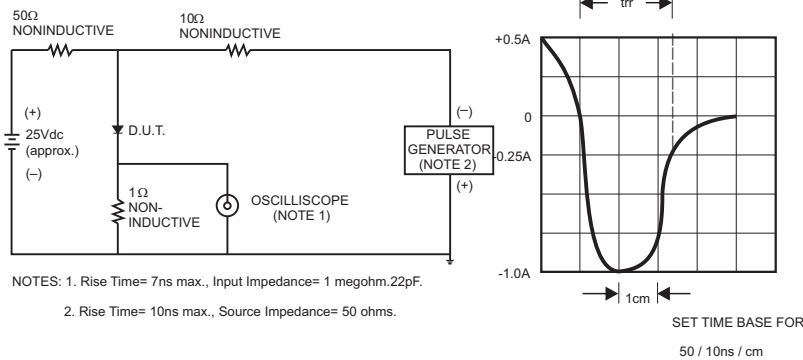


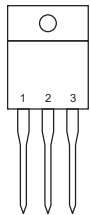
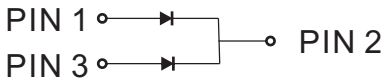
FIG.5- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm, 22pF.  
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

# SF1005FCT THRU SF1060FCT

## Pinning information

Pin	Simplified outline	Symbol
Pin1 anode Pin2 cathode Pin3 anode		

## Marking

Type number	Marking code
SF1005FCT	SF1005FCT
SF1010FCT	SF1010FCT
SF1020FCT	SF1020FCT
SF1040FCT	SF1040FCT
SF1060FCT	SF1060FCT

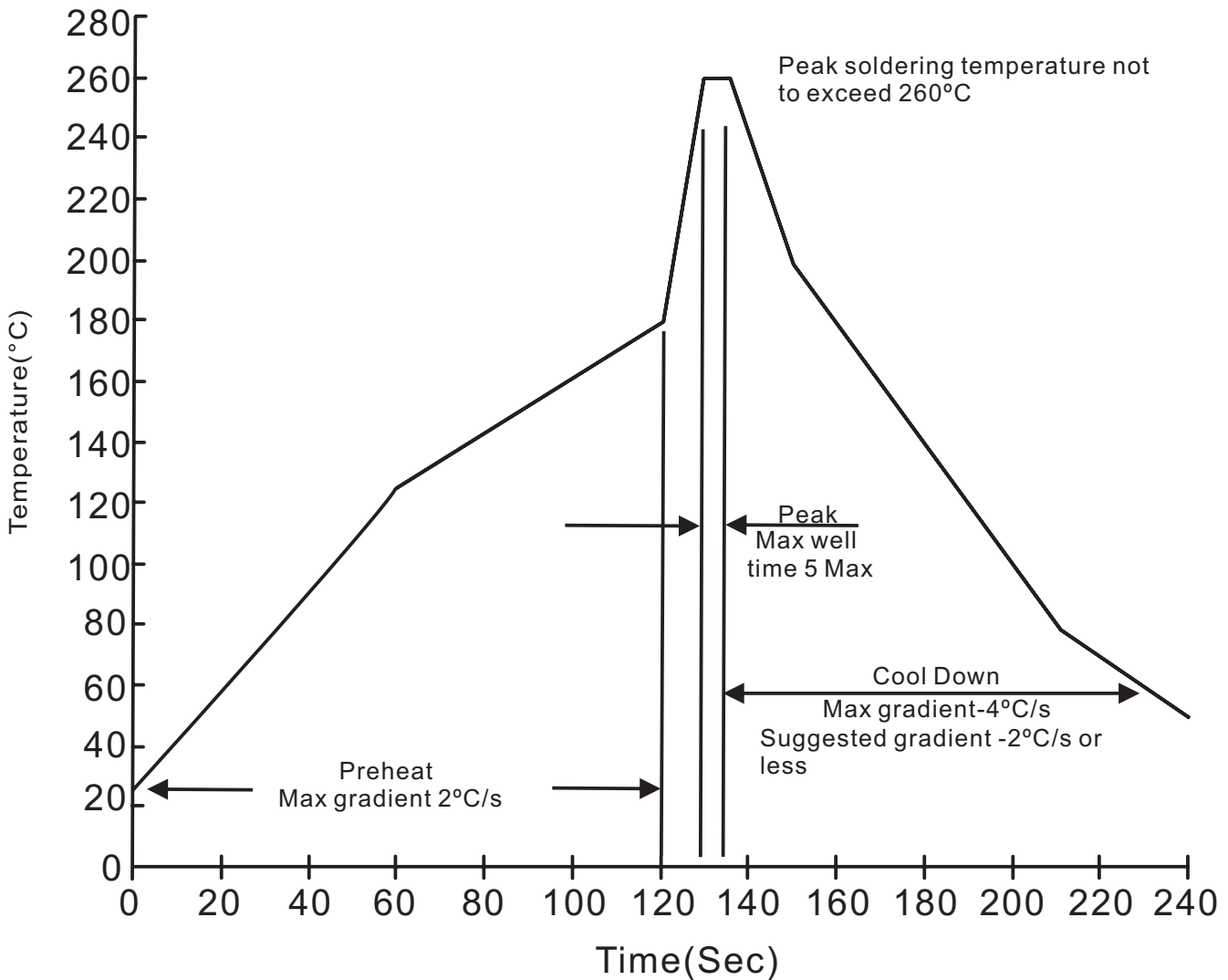
## Tube packing

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
ITO-220AB	50	535*32*7.0	2000	550*167*75	570*345*170	8,000	23.0

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## Suggested thermal profiles for soldering processes

### 1. Lead free temperature profile wave-soldering



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## High reliability test capabilities

Item Test	Conditions	Reference
1. Solder Resistance	at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec}$ . immerse body into solder $1/16''\pm 1/32''$	MIL-STD-750D METHOD-2031
2. Solderability	at $245\pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R=80\%$ rate at $T_J=150^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$ , $I_F = I_O$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at $T_A=85^{\circ}\text{C}$ , RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at $175^{\circ}\text{C}$ for 1000 hrs.	MIL-STD-750D METHOD-1031